



# BLDC Position Control

Motor Driver IC and a 32-bit MCU in a 7 x 7 mm Footprint



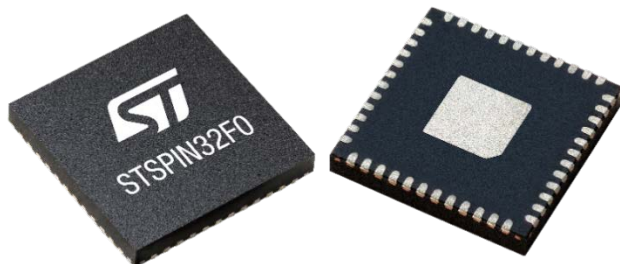
**STSPIN32F0 Key Features and Benefits**

**Position Control Demo**

**MCU for Motor Control**

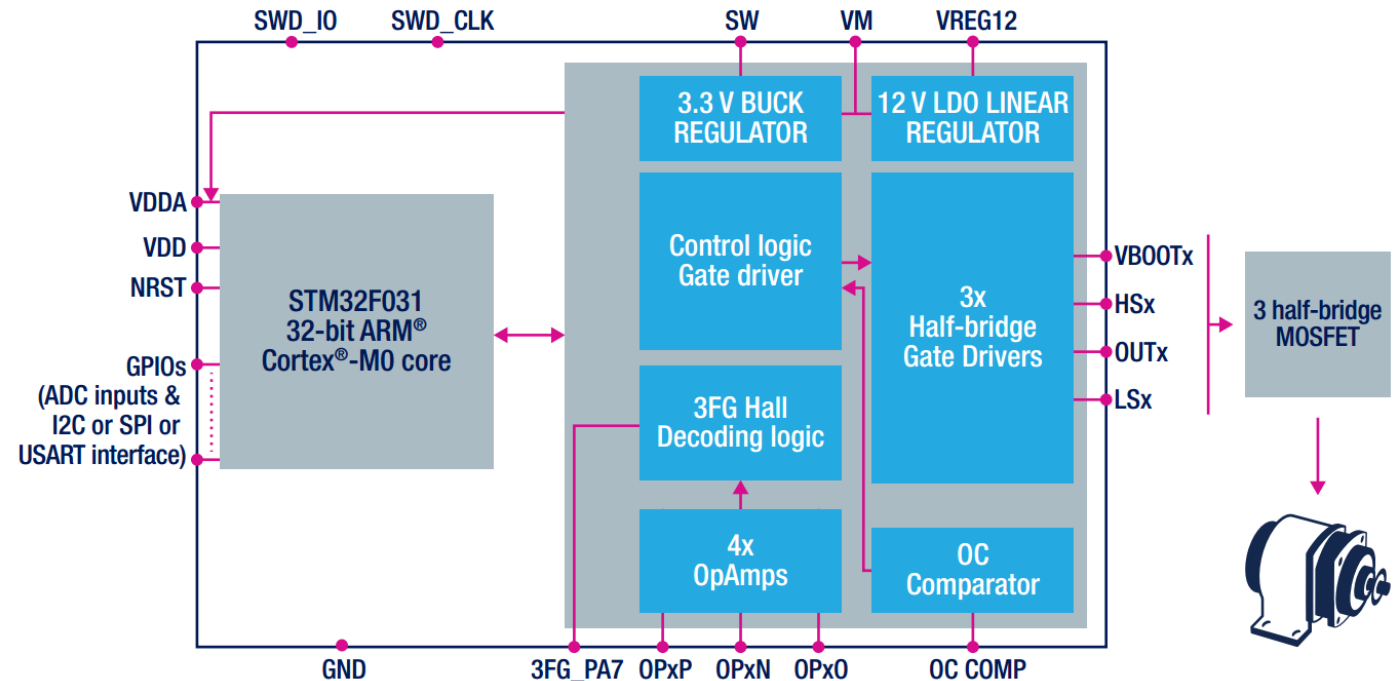
**ANALOG and POWER for Motor Control**

**Design Support Tools**



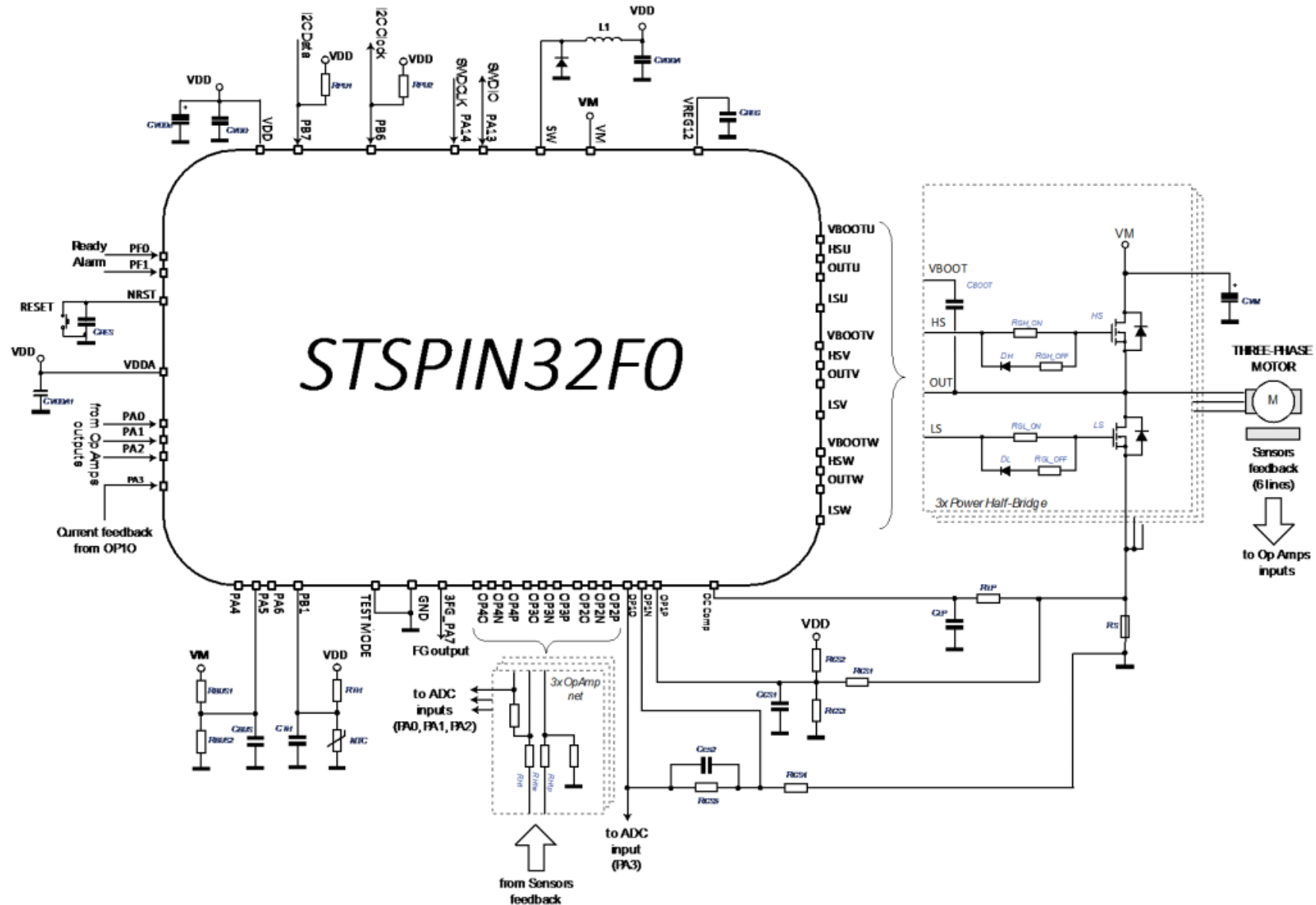
# STSPIN32F0 Technical Details

- **Operating voltage from 8V to 45V**
- **3-phase gate driver for high performances**
  - 600mA current capability
  - Real-time programmable over current
  - Integrated bootstrap diodes
  - Cross conduction, under-voltage and temperature protections
- **32-bit STM32F0 MCU with ARM® Cortex® M0 Core**
  - STM32F031x6x7 48MHz, 4-Kbyte SRAM and 32-Kbyte Flash memories
  - 12-bit ADC
  - 1 to 3 shunts FOC supported
  - Communication interfaces I2C, UART and SPI
  - Complete Development Ecosystem available
- **4x Operational Amplifiers and a Comparator**
  - Sensor-less or Hall-effect sensors supported for accurate control of 3-phase motors
  - Wide Bandwidth 20MHz
  - Adjustable Comparator's threshold
- **On-chip generated supplies for MCU driver and external circuitry**
  - 3.3V DC/DC buck regulator – Input voltage up to 45V
  - 12V LDO linear regulator
  - UVLO protection on all power supply voltages
- **Embedded Over-Temperature Protection**



- **Package : VFQFPN 7 x 7 x 1.0 - 48L**

# STSPIN32F0 Application Example



# Hardware Platform

## STEVAL-SPIN3201



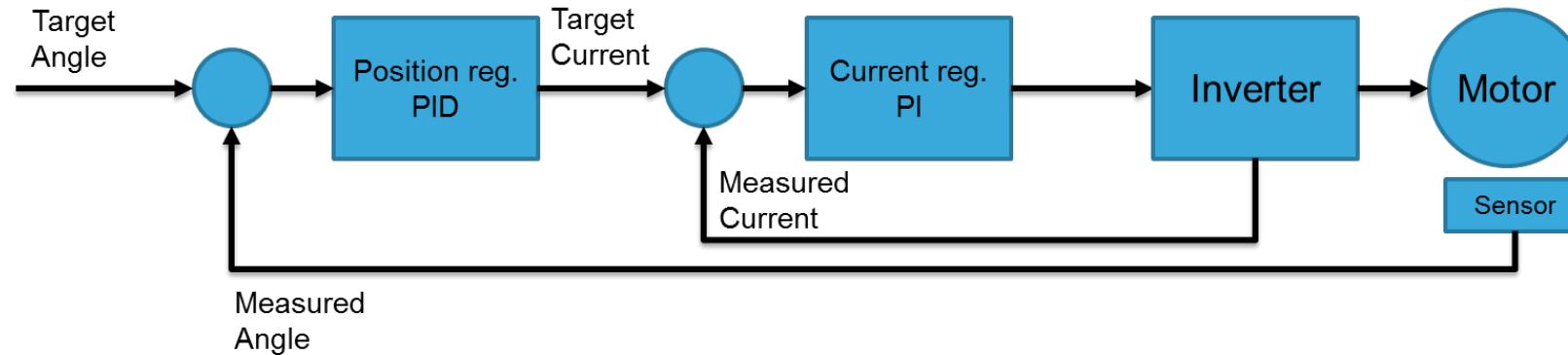
- Input voltage from 8 V to 45 V
- Output current up to 15 Arms
- Power stage based on STD140N6F7 MOSFETs
- 3-shunt current sensing
- Digital Hall sensors and encoder input
- Overcurrent comparator
- Bus voltage sensing
- Fully supporting STM32 PMSM FOC Software Development Kit
- Embedded ST-LINK/V2-1

## STSPIN32F0



- Three-phase gate drivers
  - 600 mA sink/source
  - Integrated bootstrap diodes
  - Cross-conduction prevention
- 32-bit ARM® Cortex®-M0 core:
  - Up to 48 MHz clock frequency
  - 4-kByte SRAM
  - 32-kByte Flash memory
- 16 GPIO
- 5 general-purpose timers
- 12-bit ADC converter (up to 9 channels)
- I2C, USART and SPI interfaces
- 4 rail-to-rail operation amplifiers
- Extended temperature range: -40 to +125 °C

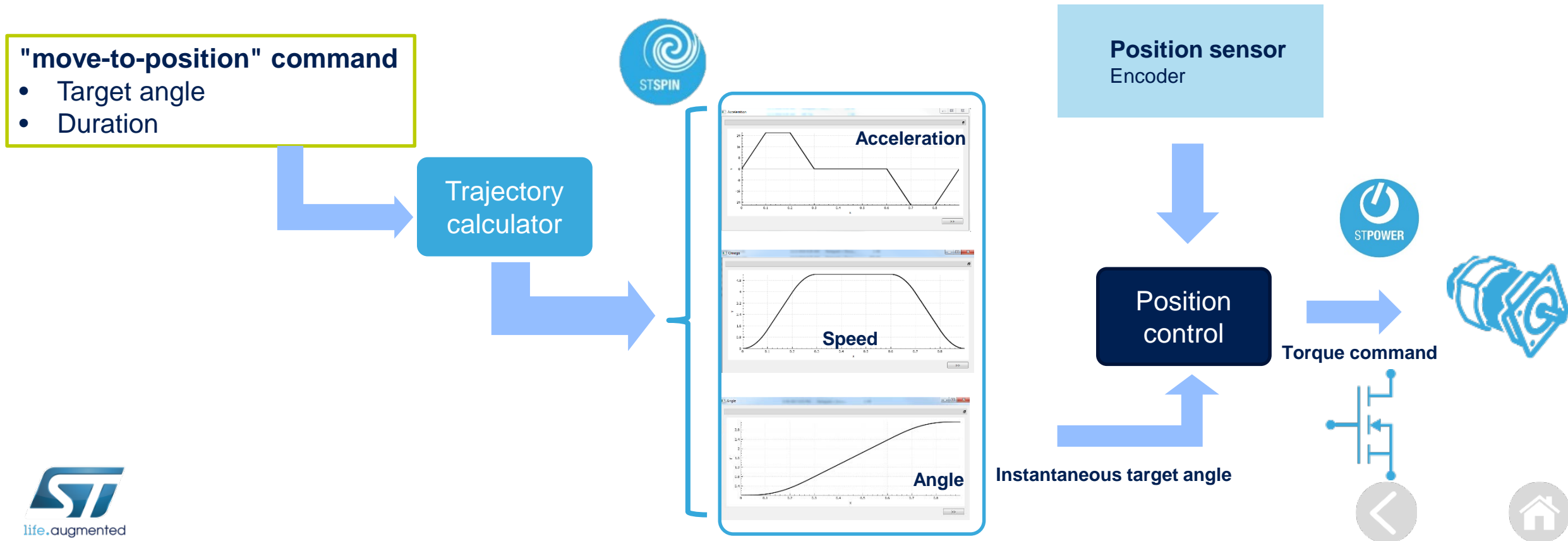
# The Demo



- Two small motors are precisely synchronized allowing the intersection of two disks, performing accurate **position control** and thus avoiding collision, playing at different speeds and accelerations.
- With **STSPIN32F0** as main core, the demo show the capabilities of a **servo drive**.

# Full Featured Position Control

- A dedicated **trajectory** (as a sequence of target positions) is calculated starting from a
- "move-to-position" command.
- The trajectory is computed applying a constant angular **Jerk** approach.
- The Jerk is the rate of change of acceleration; that is, the time derivative of acceleration.

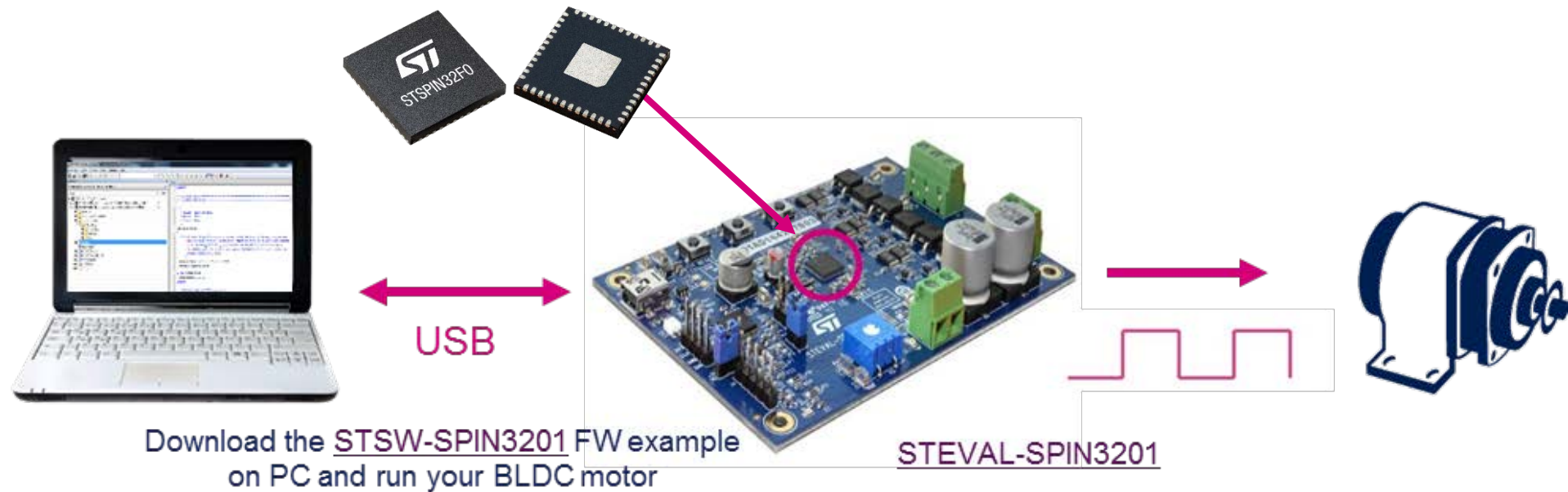






# Design Support Tools

A complete environment for the development of an FOC solution





# Making Your Designs Easier

To support STSPIN32F0, a comprehensive set of design tools is available, including:

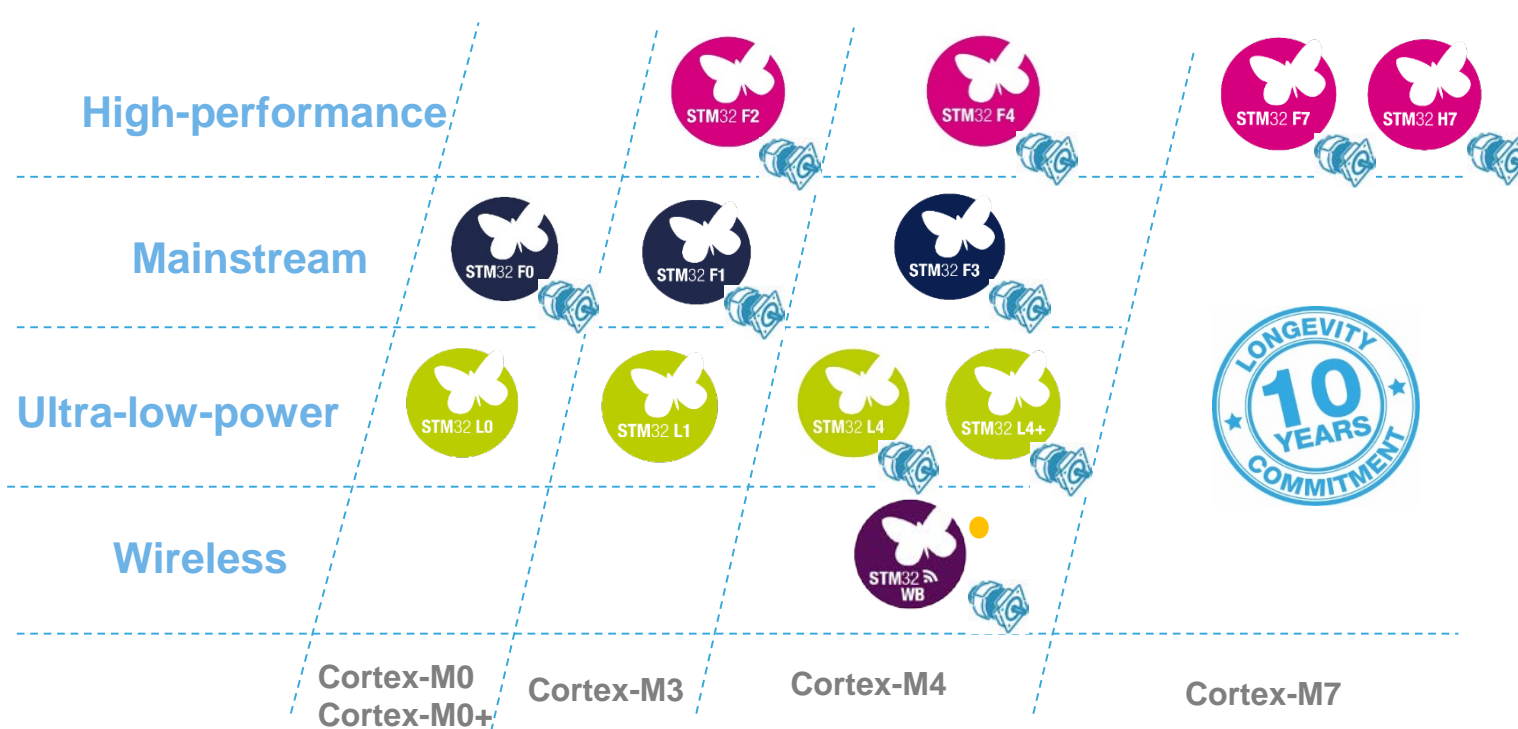
Reference Code	Description
<b>STEVAL-SPIN3201</b>	<p>STSPIN32F0 evaluation board</p> <p>Three-phase brushless DC motor driver evaluation board</p> <ul style="list-style-type: none"><li>• Input voltage from 8 to 45 V</li><li>• Output current up to 15 Arms</li><li>• Power stage based on STD140N6F7 MOSFETs</li><li>• Sensored or sensorless field-oriented control algorithm with 3-shunt sensing</li></ul>
<b>UM2154</b>	User manual for STEVAL-SPIN3201: advanced BLDC controller with embedded STM32 MCU evaluation board
<b>STSW-SPIN3201</b>	Firmware example for field oriented motor control (FOC)
<b>UM2152</b>	User manual for Getting started with the STSPIN32F0 FOC firmware example STSW-SPIN3201
<b>STSW-STM32100</b>	Library: STM32 PMSM FOC Software Development Kit





# STM32 Portfolio

12 Product Series / More than 50 Product Lines

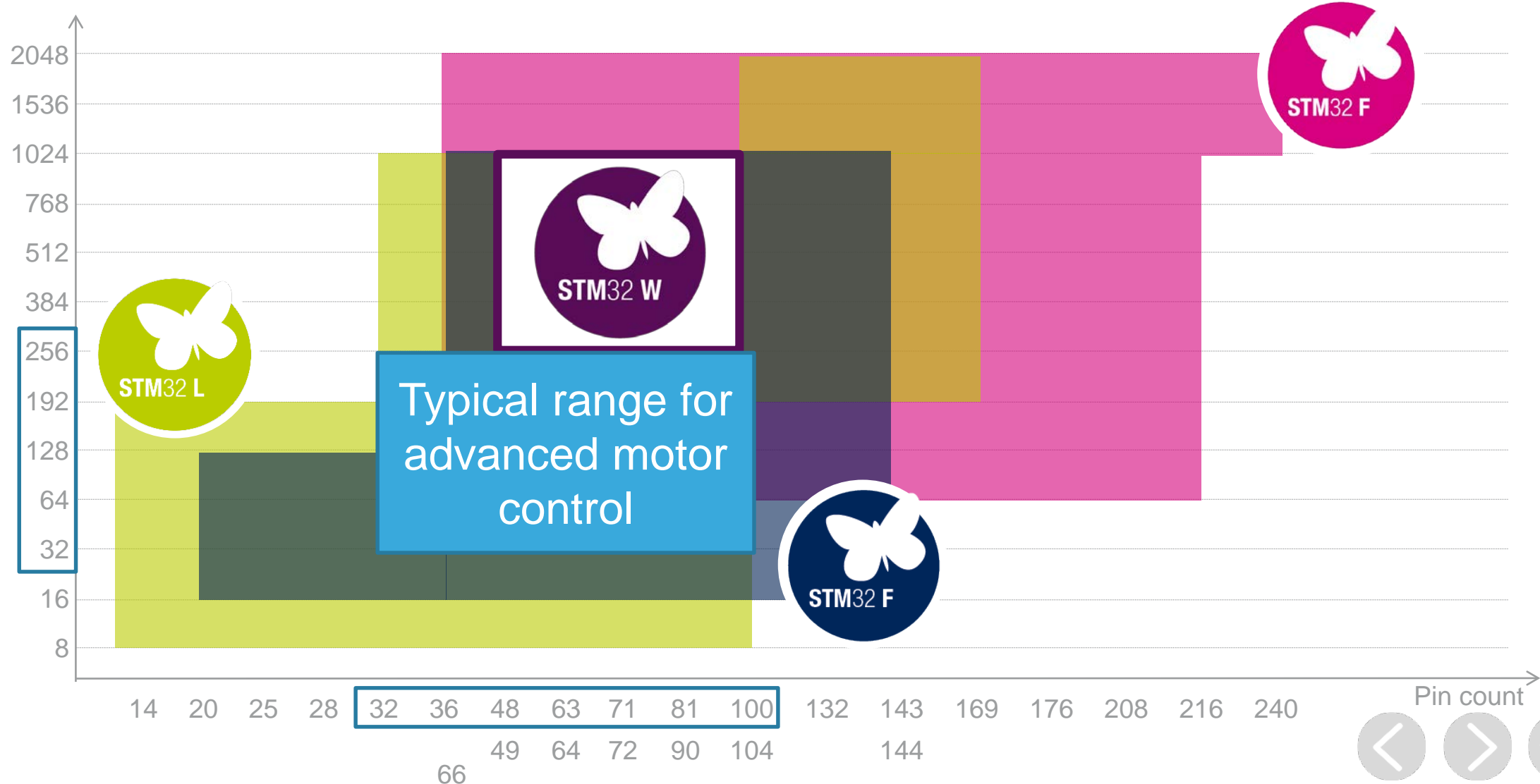


More than  
40,000 customers

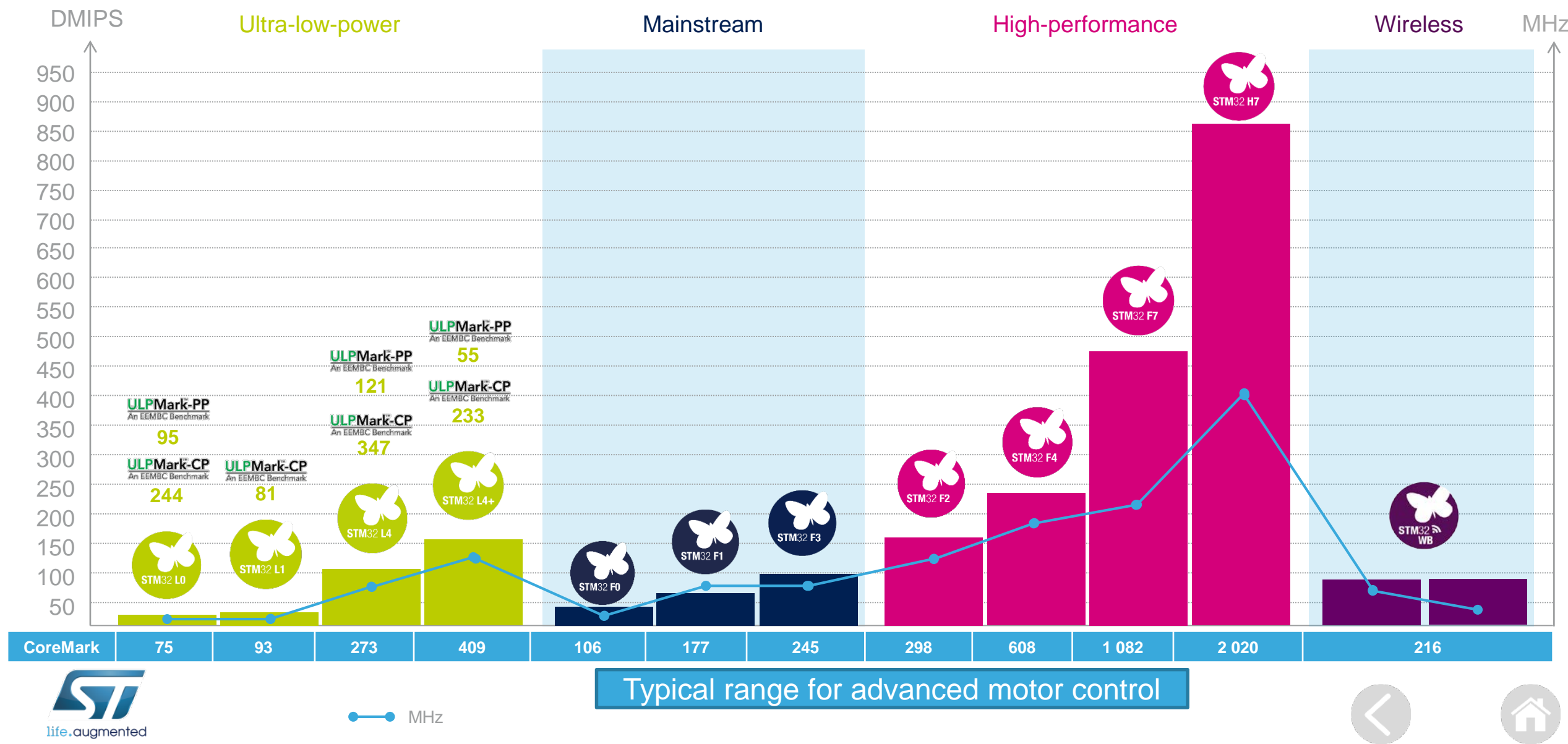
# STM32 today – platform effect

Select the Best Fitting Product from a Wide & Compatible Portfolio

Flash memory size (Kbytes)



# Broadest 32-bit MCU product portfolio





# STDRIVE – Product Family and Positioning

## IGBT and MOSFET Drivers

### Applications

Auto  
HEV/EV

1200V  
inverters

Industrial  
Drives

Washing  
machines

Compressors

Dish washers

HID

E-bikes

Server

UPS

DC/DC Auto

Solar

Factory  
automation

### Low & High Voltage Gate Drivers

#### L638xE SERIES

600V HB drivers for IGBT/MOS

#### L639x SERIES

600V HB drivers for IGBT/MOS  
optimized for FOC

#### L649x SERIES

600V high current HB drivers for  
IGBT/MOS

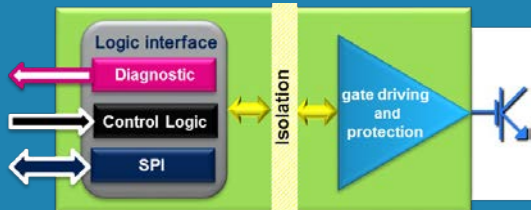
#### TD3xxE

Single channel drivers with functional  
isolation & 2-level turn-off

600V

### Galvanically isolated Gate Drivers

#### • STGAP1AS



1.5kV

50W

200W

1kW

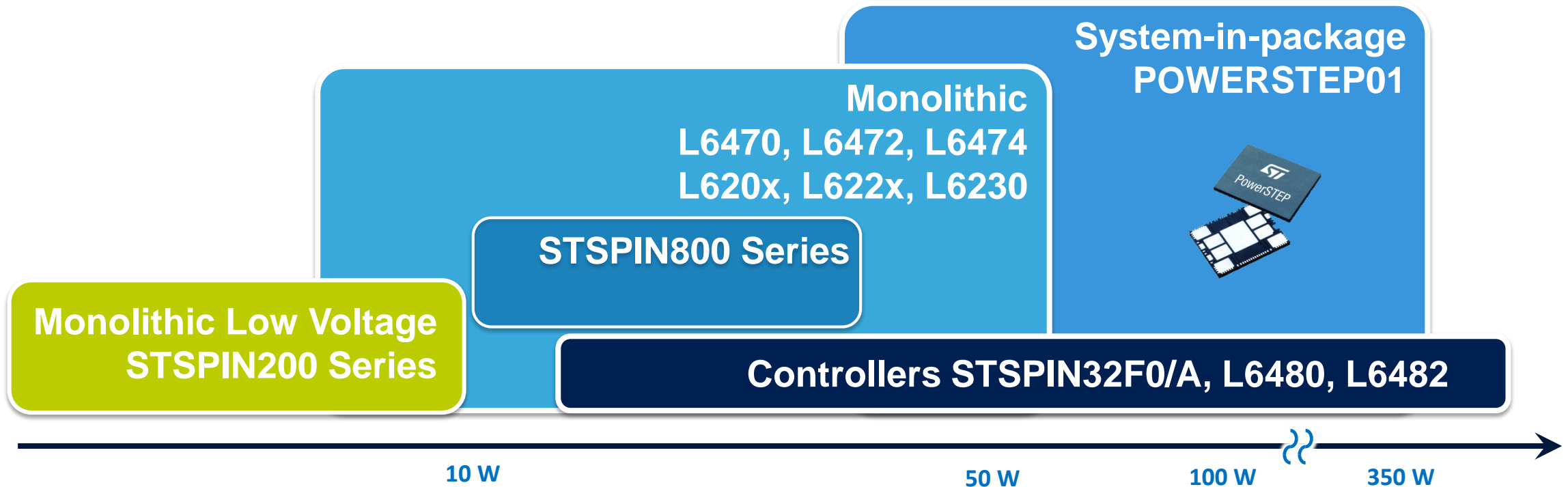
100kW

Power



# STSPIN Family Portrait

Leading Integration, Performance, Efficiency



Portable, Battery Powered

Medical, Security, ATM, Vending,  
3D Printers, Domotics



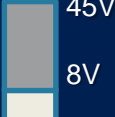




Stage Lighting

Industrial, Factory Automation





# STSPIN Family Positioning

	Monolithic motor drivers 	LV motor drivers 	Microstepping motor drivers 	High Power microstepping 
<b>STEPPER</b> 	Dual full-bridges L6208 L6228 L6208Q L6228Q STSPIN820	Dual full-bridge STSPIN220	Dual full-bridges L6470 (VM) L6474 L6472 (PCAD)	Controllers & SiP L6480 (VM) L6482 (PCAD) POWERSTEP01
<b>BRUSHED DC</b> 	Dual full-bridges L6205 L6225 L6206/Q L6226/Q L6207/Q L6227/Q STSPIN840	Dual full-bridge STSPIN240 STSPIN250		
<b>3-PHASE BLDC</b> 	Triple half-bridges L6235/Q L6229/Q L6234 L6230/Q STSPIN830	Triple half-bridge STSPIN230 STSPIN233		

**VM** = Voltage mode

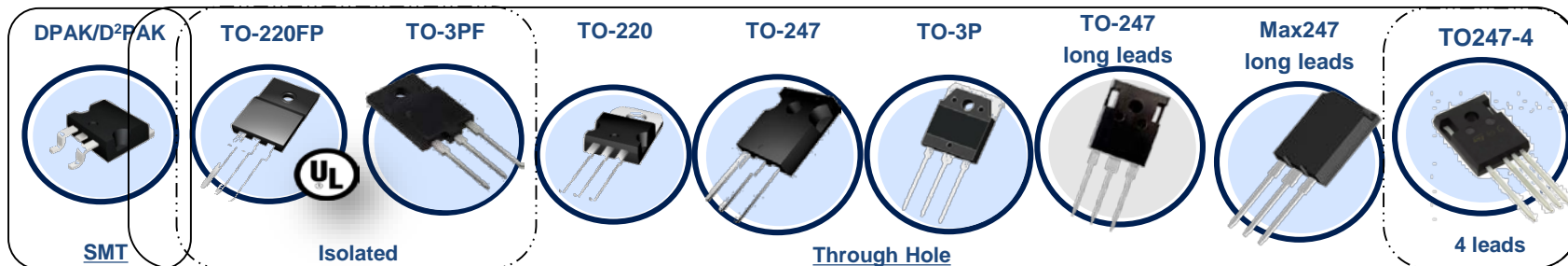
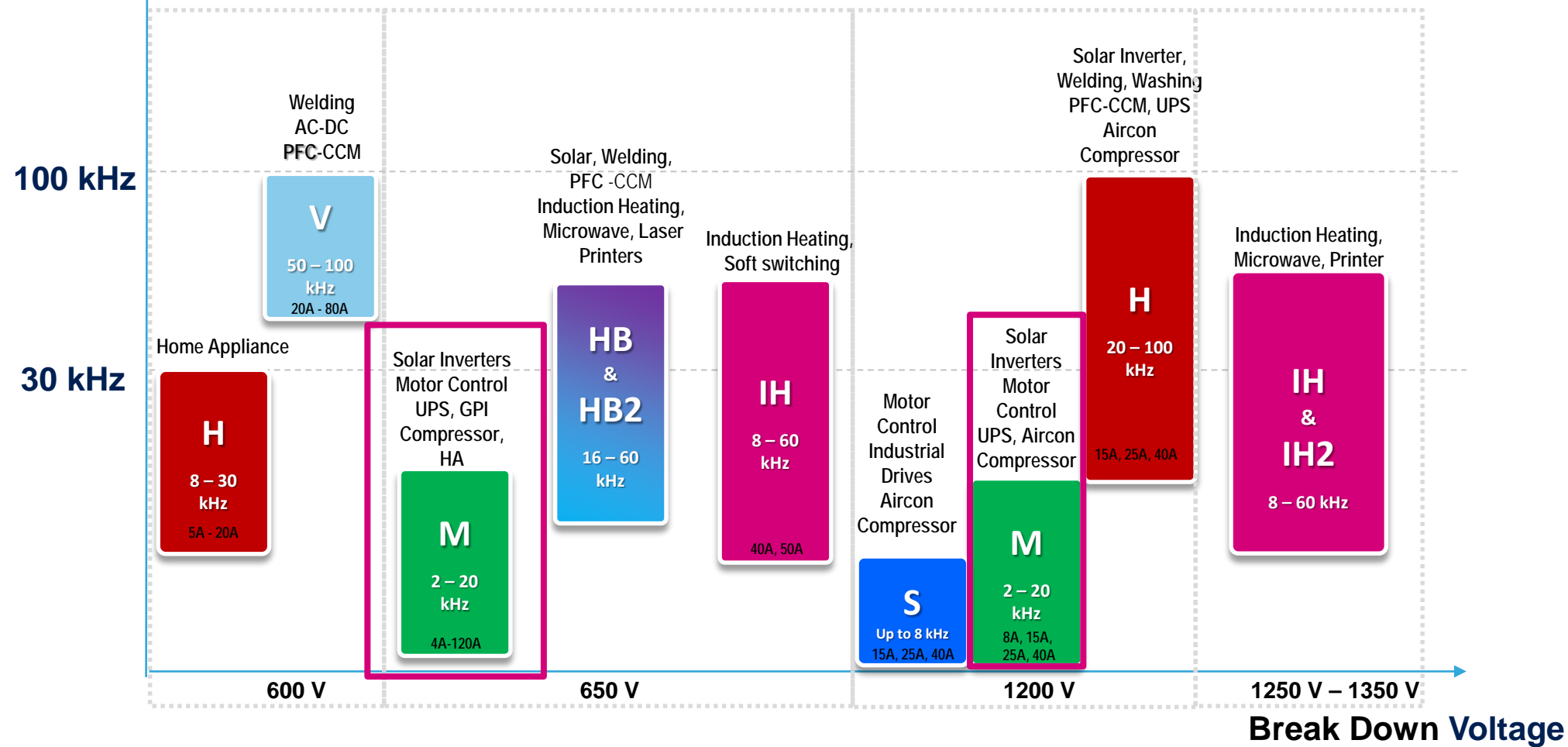
**PCAD** = Predictive Current control with Adaptive Decay

**DME** = Digital Motion Engine generates motion profiles thru commands sent over SPI

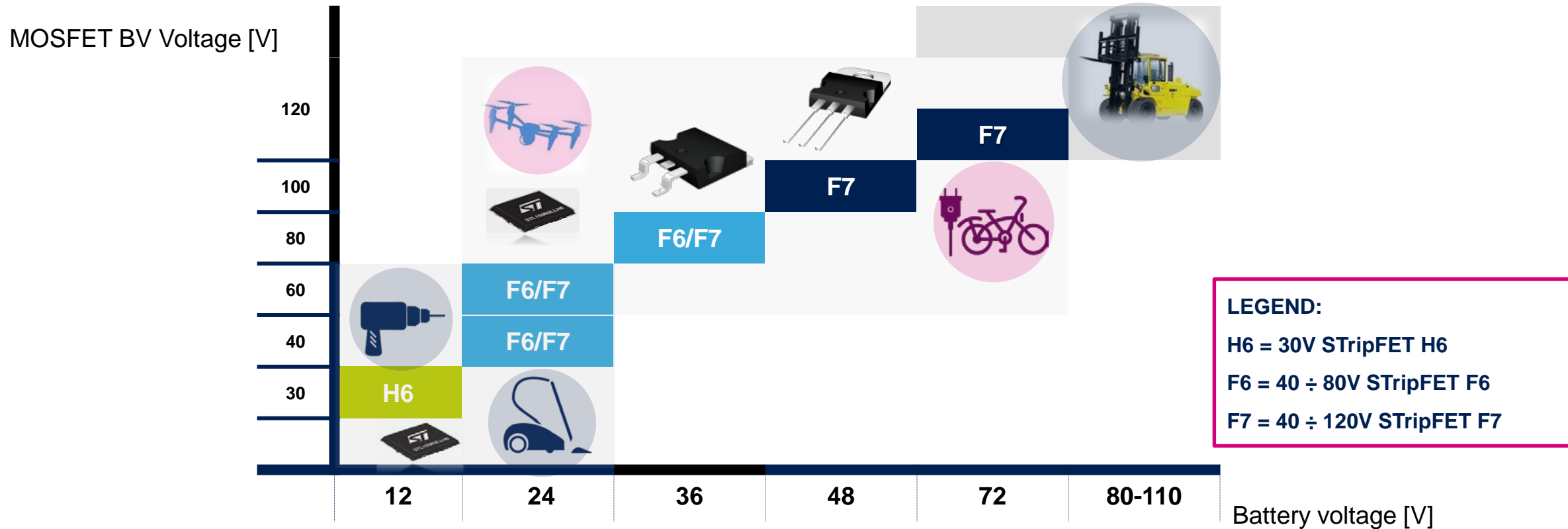


# IGBTs positioning (from 600V to 1350V)

Switching frequency



# Low Voltage STripFET™ Positioning vs Battery Voltage



## Technology Features

- Best in class On-resistance
- High current capability
- High quality & reliability
- Wide packaging options

## Benefits

- Higher efficiency and system miniaturization
- Lower battery consumption
- Reliable system operation

# Discrete vs Integrated Approach



## Advantages of integrated Power Modules (IPM)

High power dissipation due to a very low thermal resistance

Lower losses and EMI noise thanks to simultaneous optimization of power chips and driving circuits

«Plug 'n Play» solution

Improved manufacturability and PCB routing, only one component to handle

Reduced design time and improved reliability thanks to embedded protection

# SLLIMM™ Intelligent Power Modules

## Target applications

Motor control



Washing Machine



Air Conditioning



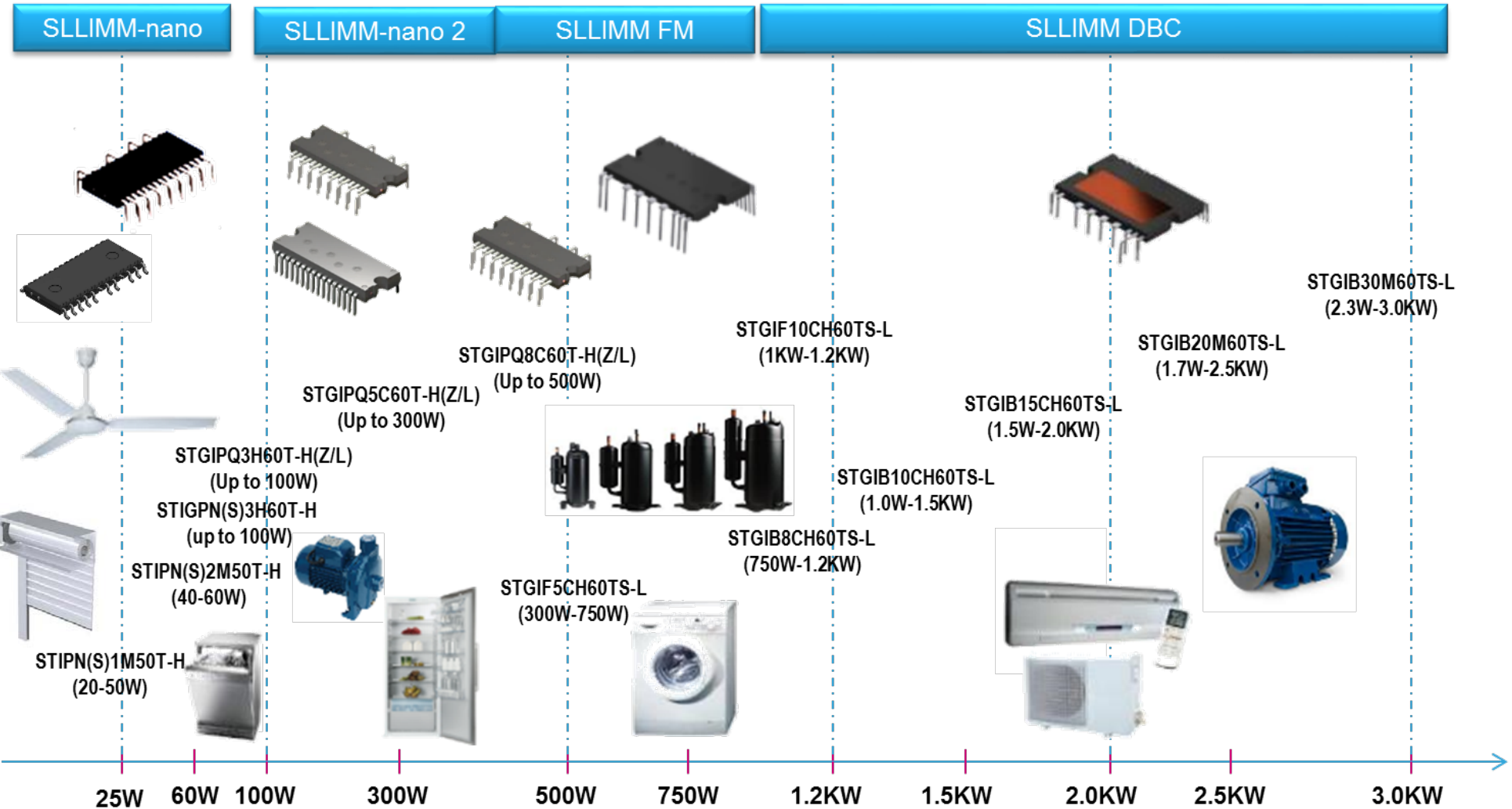
Pumps



Compressor



Industrial drives



## Main Features and ST capability in “Power Switch”

ACEPACK™ 2

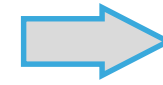


ACEPACK™ 1



### Main Features

- Compact module concept
- Configuration flexibility
- Press FIT and solder pins options
- High power density
- Reliable and easy mounting system
- Integrated temperature sensor available
- Low stray inductance module design
- PCB layout design
- High reliability and quality
- RoHS-compliant modules



### ST Power Switch capability

- IGBTs
- HV MOSFETs
- Diodes
- Bridge Rectifier Diodes
- Silicon Carbide MOSFETs
- Silicon Carbide Diodes
- SCR

### Main Topologies can be addressed in ACEPACK

